DALLAS JUIXI

DS1220Y 16k Nonvolatile SRAM

www.maxim-ic.com

FEATURES

- 10 years minimum data retention in the absence of external power
- Data is automatically protected during power loss
- Directly replaces 2k x 8 volatile static RAM or EEPROM
- Unlimited write cycles
- Low-power CMOS
- JEDEC standard 24-pin DIP package
- Read and write access times as fast as 100 ns
- Full ±10% operating range
- Optional industrial temperature range of -40°C to +85°C, designated IND

PIN ASSIGNMENT

A7	1	24	VCC
A6	\square_2	23	A8
A5		22 🔲	A9
A4	∎4	21	WE
A3	∎5	20 🛛	OE
A2	□ 6	19 🛯	<u>A1</u> 0
A1	07	18 🔲	CE
A0	∎8	17 🔲	DQ7
DQ0	∎9	16 🛙	DQ6
DQ1	∎ 10	15 I	DQ5
DQ2	1 1	14 I	DQ4
GND	12	13 🗖	DQ3

24-Pin ENCAPSULATED PACKAGE 720-mil EXTENDED

PIN DESCRIPTION

A0-A10	- Address Inputs
DQ0-DQ7	- Data In/Data Out
CE	- Chip Enable
WE	- Write Enable
ŌĒ	- Output Enable
V _{CC}	- Power (+5V)
GND	- Ground

DESCRIPTION

The DS1220Y 16k Nonvolatile SRAM is a 16,384-bit, fully static, nonvolatile RAM organized as 2048 words by 8 bits. Each NV SRAM has a self-contained lithium energy source and control circuitry that constantly monitor V_{CC} for an out-of-tolerance condition. When such a condition occurs, the lithium energy source is automatically switched on and write protection is unconditionally enabled to prevent data corruption. The NV SRAM can be used in place of existing 2k x 8 SRAMs directly conforming to the popular bytewide 24-pin DIP standard. The DS1220Y also matches the pinout of the 2716 EPROM or the 2816 EEPROM, allowing direct substitution while enhancing performance. There is no limit on the number of write cycles that can be executed and no additional support circuitry is required for microprocessor interfacing.

The DS1220Y executes a read cycle whenever \overline{WE} (Write Enable) is inactive (high) and \overline{CE} (Chip Enable) and \overline{OE} (Output Enable) are active (low). The unique address specified by the 11 address inputs (A0-A10) defines which of the 2048 bytes of data is to be accessed. Valid data will be available to the eight data output drivers within t_{ACC} (Access Time) after the last address input signal is stable, providing that \overline{CE} and \overline{OE} access times are also satisfied. If \overline{CE} and OE access times are not satisfied, then data access must be measured from the later-occurring signal and the limiting parameter is either t_{CO} for \overline{CE} or t_{OE} for \overline{OE} rather than address access.

WRITE MODE

The DS1220Y executes a write cycle whenever the \overline{WE} and \overline{CE} signals are active (low) after address inputs are stable. The later-occurring falling edge of \overline{CE} or \overline{WE} will determine the start of the write cycle. The write cycle is terminated by the earlier rising edge of \overline{CE} or \overline{WE} . All address inputs must be kept valid throughout the write cycle. \overline{WE} must return to the high state for a minimum recovery time (t_{WR}) before another cycle can be initiated. The \overline{OE} control signal should be kept inactive (high) during write cycles to avoid bus contention. However, if the output drivers are enabled (\overline{CE} and \overline{OE} active) then \overline{WE} will disable the outputs in t_{ODW} from its falling edge.

DATA RETENTION MODE

The DS1220Y provides full-functional capability for V_{CC} greater than 4.5 volts and write protects at 4.25 nominal. Data is maintained in the absence of V_{CC} without any additional support circuitry. The DS1220Y constantly monitors V_{CC} . Should the supply voltage decay, the NV SRAM automatically write protects itself, all inputs become "don't care," and all outputs become high-impedance. As V_{CC} falls below approximately 3.0 volts, a power switching circuit connects the lithium energy source to RAM to retain data. During power-up, when V_{CC} rises above approximately 3.0 volts, the power switching circuit connects external V_{CC} to RAM and disconnects the lithium energy source. Normal RAM operation can resume after V_{CC} exceeds 4.5 volts.

ABSOLUTE MAXIMUM RATINGS*

Voltage on Any Pin Relative to Ground	-0.
Operating Temperature	0°0
Storage Temperature	-4(
Soldering Temperature	+2
Caution: Do Not Reflow	(W

0.3V to +7.0V 0°C to 70°C; -40°C to +85°C for IND parts 40°C to +70°C; -40°C to +85°C for IND parts +260°C for 10 seconds (Wave or Hand Solder Only)

This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operation sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods of time may affect reliability.

RECOMMENDED DC OF	(T _A : See	Note 10)				
PARAMETER	SYMBOL	MIN	ТҮР	MAX	UNITS	NOTES
Power Supply Voltage	V _{CC}	4.5	5.0	5.5	V	
Input Logic 1	V _{IH}	2.2		V _{CC}	V	
Input Logic 0	V _{IL}	0.0		+0.8	V	

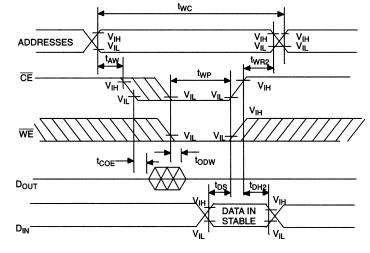
DC ELECTRICAL CHARAC	TERISTIC	S (1	A : See	Note 10	; V _{CC} = 5	V ± 10%)
PARAMETER	SYMBOL	MIN	ТҮР	MAX	UNITS	NOTES
Input Leakage Current	I _{IL}	-1.0		+1.0	μA	
I/O Leakage Current	I _{IO}	-1.0		+1.0	μΑ	
$\overline{CE} \ge V_{IH} \le V_{CC}$						
Output Current @ 2.4V	I _{OH}	-1.0			mA	
Output Current @ 0.4V	I _{OL}	2.0			mA	
Standby Current $\overline{\text{CE}} = 2.2\text{V}$	I _{CCS1}		3.0	7.0	mA	
Standby Current $\overline{CE} = V_{CC} - 0.5V$	I _{CCS2}		2.0	4.0	mA	
Operating Current t _{CYC} = 200ns	I _{CCO1}			75	mA	
(Commercial)						
Operating Current t _{CYC} =200ns	I _{CCO1}			85	mA	
(Industrial)						
Write Protection Voltage	V _{TP}		4.25		V	

CAPACITANCE					(T	_A = 25°C)
PARAMETER	SYMBOL	MIN	ТҮР	MAX	UNITS	NOTES
Input Capacitance	C _{IN}		5	10	pF	
Input/Output Capacitance	C _{I/O}		5	12	pF	

NOT RECOMMENDED FOR NEW DESIGNS

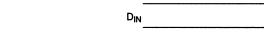
DS1220Y

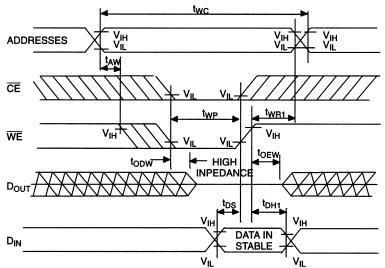
AC ELECTRICAL CHARACTERISTICS						(T _A : See Note 10; V _{CC} =5.0V ±				± 10%)	
PARAMETER	SYM		20Y-100		0Y-120		20Y-150		20Y-200	UNITS	NOTE
		MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX		
Read Cycle Time	t _{RC}	100		120		150		200		ns	
Access Time	t _{ACC}		100		120		150		200	ns	
\overline{OE} to Output Valid	t _{OE}		50		60		70		100	ns	
\overline{CE} to Output Valid	t _{CO}		100		120		150		200	ns	
\overline{OE} or \overline{CE} to Output Active	t _{COE}	5		5		5		5		ns	5
Output High-Z from Deslection	t _{OD}		35		35		35		35	ns	5
Output Hold from Address Change	t _{OH}	5		5		5		5		ns	
Write Cycle Time	twc	100		120		150		200		ns	
Write Pulse Width	t _{WP}	75		90		100		150		ns	3
Address Setup Time	t _{AW}	0		0		0		0		ns	
Write Recovery Time	t _{WR1} t _{WR2}	0 10		0 10		0 10		0 10		ns ns	12 13
Output High-Z from \overline{WE}	t _{ODW}		35		35		35		35	ns	5
Output Active from WE	t _{OEW}	5		5		5		5		ns	5
Data Setup Time	t _{DS}	40		50		60		80		ns	4
Data Hold Time	t _{DH1} t _{DH2}	0 10		0 10		0 10		0 10		ns ns	12 13



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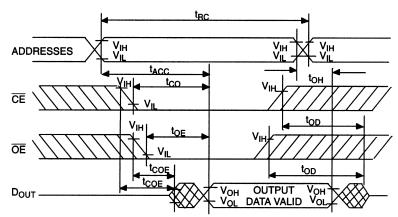
SEE NOTES 2, 3, 4, 6, 7, 8 AND 12 WRITE CYCLE 2





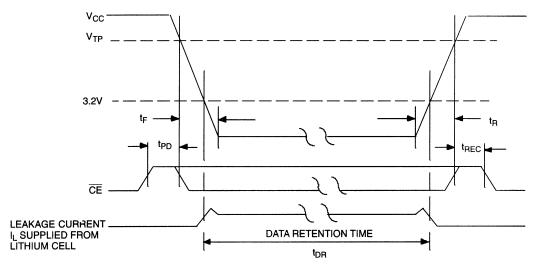
WRITE CYCLE 1

SEE NOTE 1



READ CYCLE

POWER-DOWN/POWER-UP CONDITION



SEE NOTE 11

POWER-DOWN/POWER-UP TIMING

PARAMETER	SYMBOL	MIN	MAX	UNITS	NOTES
\overline{CE} at V _{IH} before Power-Down	t _{PD}	0		μs	11
V_{CC} Slew from V_{TP} to 0V	t _F	100		μs	
V_{CC} Slew from 0V to V_{TP}	t _R	0		μs	
$\overline{\text{CE}}$ at V _{IH} after Power-Up	t _{REC}		2	ms	

				(T _A	$(= +25^{\circ}C)$
PARAMETER	SYMBOL	MIN	MAX	UNITS	NOTES
Expected Data Retention Time	t _{DR}	10		years	9

WARNING:

Under no circumstance are negative undershoots, of any amplitude, allowed when device is in battery backup mode.

NOTES:

- 1. WE is high for a read cycle.
- 2. $\overline{OE} = V_{IH}$ or V_{IL} . If $\overline{OE} = V_{IH}$ during a write cycle, the output buffers remain in a high impedance state.
- 3. t_{WP} is specified as the logical AND of \overline{CE} and \overline{WE} . t_{WP} is measured from the latter of \overline{CE} or \overline{WE} going low to the earlier of \overline{CE} or \overline{WE} going high.
- 4. t_{DS} are measured from the earlier of \overline{CE} or \overline{WE} going high.
- 5. These parameters are sampled with a 5 pF load and are not 100% tested.

- 6. If the \overline{CE} low transition occurs simultaneously with or later than the \overline{WE} low transition in write cycle 1, the output buffers remain in a high impedance state during this period.
- 7. If the \overline{CE} high transition occurs prior to or simultaneously with the \overline{WE} high transition, the output buffers remain in a high impedance state during this period.
- 8. If \overline{WE} is low or the \overline{WE} low transition occurs prior to or simultaneously with the \overline{CE} low transition, the output buffers remain in a high impedance state during this period.
- 9. Each DS1220Y is marked with a 4-digit date code AABB. AA designates the year of manufacture. BB designates the week of manufacture. The expected t_{DR} is defined as starting at the date of manufacture.
- 10. All AC and DC electrical characteristics are valid over the full operating temperature range. For commercial products, this range is 0°C to 70°C. For industrial products (IND), this range is -40°C to +85°C.
- 11. In a power-down condition the voltage on any pin may not exceed the voltage of V_{CC} .
- 12. t_{WR1} , t_{DH1} are measured from \overline{WE} going high.
- 13. t_{WR2} , t_{DH2} are measured from \overline{CE} going high.
- 14. DS1220Y modules are recognized by Underwriters Laboratories (UL®) under file E99151 (R).

DC TEST CONDITIONS

Outputs open. All voltages are referenced to ground.

AC TEST CONDITIONS

Output Load: 100pF + 1TTL Gate Input Pulse Levels: 0-3.0V Timing Measurement Reference Levels Input: 1.5V Output: 1.5V Input Pulse Rise and Fall Times: 5ns

ORDERING INFORMATION/SELECTOR GUIDE

PART	TEMP RANGE	SUPPLY	PIN-PACKAGE	SPEED GRADE
TANI	I ENIF KANGE	TOLERANCE	FIN-FACKAGE	(ns)
DS1220Y-100	0° C to $+70^{\circ}$ C	$5V \pm 10\%$	24 / 720 EMOD	100
DS1220Y-100+	0° C to $+70^{\circ}$ C	$5V \pm 10\%$	24 / 720 EMOD	100
DS1220Y-100IND	-40°C to +85°C	$5V \pm 10\%$	24 / 720 EMOD	100
DS1220Y-100IND+	-40°C to +85°C	$5V \pm 10\%$	24 / 720 EMOD	100
DS1220Y-120	0° C to $+70^{\circ}$ C	$5V \pm 10\%$	24 / 720 EMOD	120
DS1220Y-120+	0° C to $+70^{\circ}$ C	$5V \pm 10\%$	24 / 720 EMOD	120
DS1220Y-150	0°C to +70°C	$5V \pm 10\%$	24 / 720 EMOD	150
DS1220Y-150+	0° C to $+70^{\circ}$ C	$5V \pm 10\%$	24 / 720 EMOD	150
DS1220Y-200	0°C to +70°C	$5V \pm 10\%$	24 / 720 EMOD	200
DS1220Y-200+	0° C to $+70^{\circ}$ C	$5V \pm 10\%$	24 / 720 EMOD	200
DS1220Y-200IND	-40°C to +85°C	$5V \pm 10\%$	24 / 720 EMOD	200
DS1220Y-200IND+	-40°C to +85°C	$5V \pm 10\%$	24 / 720 EMOD	200

+ Denotes a lead-free/RoHS-compliant package.

For the latest package outline information, go to www.maxim-ic.com/packages.

PACKAGE TYPE	PACKAGE CODE	DOCUMENT NO.
24 DIP	_	<u>56-G0002-001</u>

24-PIN

MAX

1.340

34.04

0.720

18.29

0.415

10.54

0.130

3.30

0.030

0.76

0.160

4.06

0.110

2.79

0.630

16.00

0.012

0.30

0.021

0.53

MIN

1.320

33.53

0.695

17.65

0.390

9.91

0.100

2.54

0.017

0.43

0.120

3.05

0.090

2.29

0.590

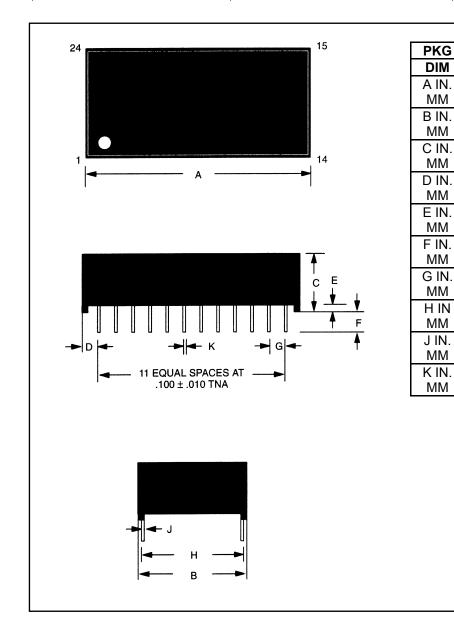
14.99

0.008

0.20

0.015

0.38



REVISION HISTORY							
REVISION DATE	DESCRIPTION	PAGES CHANGED					
121907	Added the <i>Package Information</i> table; removed the DIP module package drawing and dimension table.	7					
072808	Added the DIP module package drawing and dimension table.	8					

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